

Tool ID: 319  
Tool Location: 102

## Equipment Information Sheet

# Veeco Savannah ALD

**Manager: Jeremy Clark 607-254-6487**  
**Backup: Philip Schneider 607-254-4931**

Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times leave a message or send them an email.

### SAFETY

- Uses highly toxic & reactive / pyrophoric precursors for film deposition. Materials are monitored by TGMCS.

### USAGE RESTRICTIONS

### SCHEDULING/SIGN-UP RESTRICTIONS

*Minimum Tool Time: 15 minutes*

### MATERIALS COMPATIBILITY CATEGORY

#### Tool Category 4: Glass and Metal Categories

Allowed	Not Allowed
Tool category 1/1E, 2, and 3 materials	
Silicon Based Substrates and Films	No CNF Class A metals
III/V compound Semiconductors	<b>No Exposed CNF Group B metals- <i>metals can be buried/covered with staff approval</i></b>
Glass Substrates	Cannot be used as an etch stop
PECVD and ALD Films	
Buried Class B Metals with approval	
Organic/Bio Materials prepped w/o Salt Buffers	
Cured organics and baked Photoresist	No High Vapor pressure materials

**High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.**

### Additional Material Restrictions and Exceptions

- No films thicker than 50nm or 500 loops without permission of the tool manager
- All sizes from pieces to 200mm wafers allowed

*Last Updated: 04/30/2026*